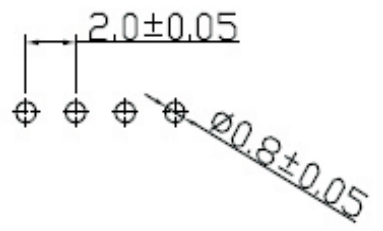
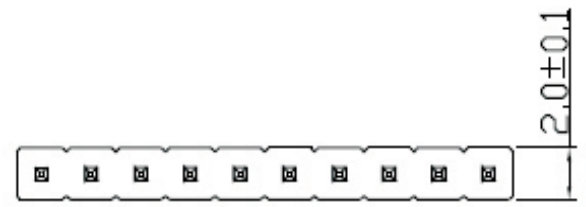
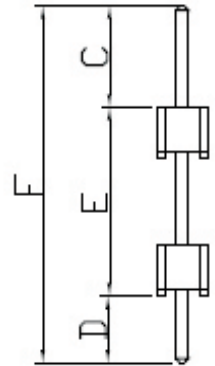
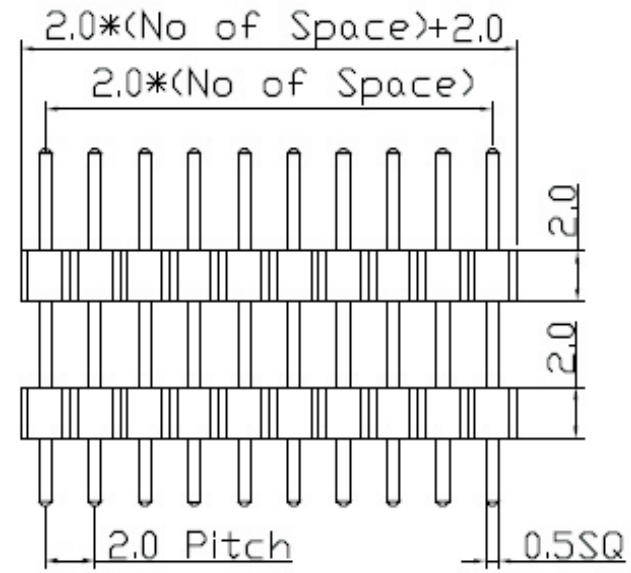


REV	ECN. NO.	APP	DATE
A	EDIÇÃO INICIAL		



P.C.Board Layout

SPECIFICATIONS

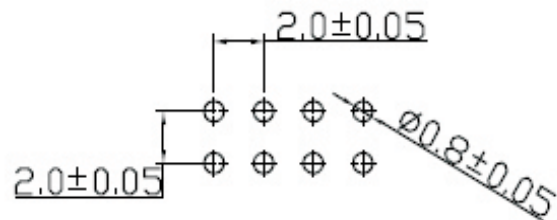
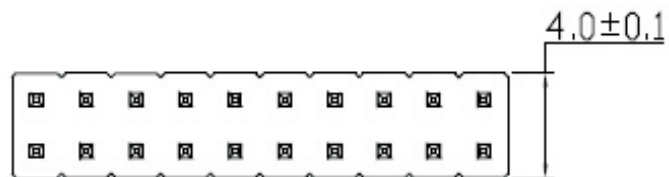
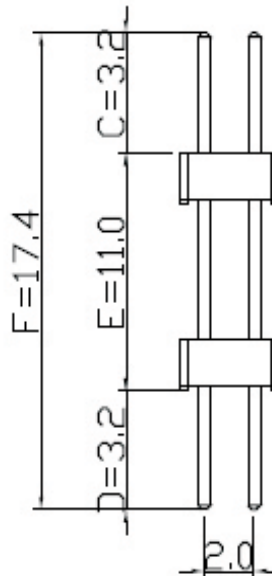
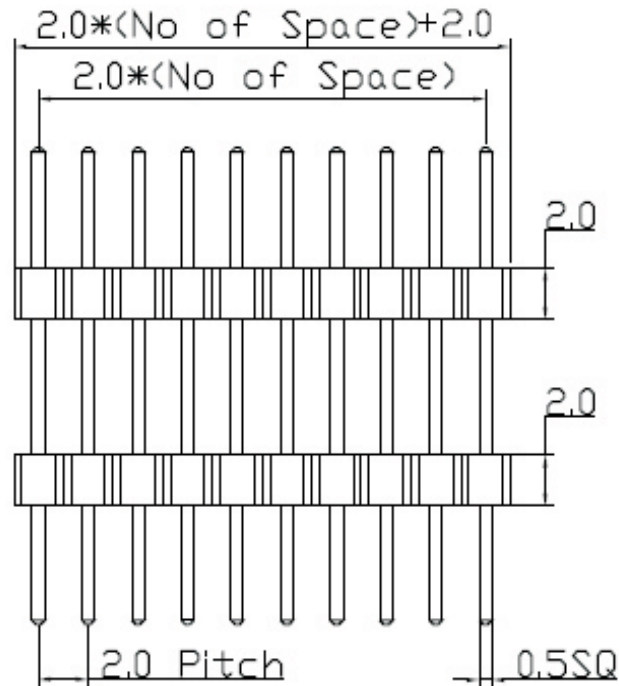
Current Rating: 2 Amps
 Dielectric Withstanding: AC 500V
 Operating Temperature: -40°C to +105°C
 Max Processing Temp.: 230° for 30~60 seconds
 (260° for 10 seconds)

HOW TO ORDER:
MCT[][S][R][]S2[G][][R]
1 2 3 4 5 6 7

- 1- Nr. of Ways
Single Row: 1 to 40
- 2- Row Version:
(S)-Single Row
- 3- Pin Style
(N)-90°
(R)-180°
- 4- Terminal Plating:
(E)-Sn
(F)-FLASH Au
(A)-0,38um Au
(B)-0,76um Au
(C)-0,38um Au/Sn
(D)-0,76um Au/Sn
- 5- Profile:
(G)-2,0mm
- 6- Options:
(T)-Tube Packing
- 7- (R) RoHS Compliant

		MATRIX TECNOLOGIA IND. E COM. LTDA.	
UNIT mm	SCALE	TITLE 2.0x2.0mm MCT H=2.0mm SINGLE ROW	DATE SEPTEMBER 2007
TOLERANCE: ±0.25			APP. BY
		MATL	CHK. BY
		DWG. NO.	DR. BY DIEGO

REV	ECN. NO.	APP	DATE
A	EDIÇÃO INICIAL		



P.C. Board Layout

SPECIFICATIONS

Current Rating: 2 Amps

Dielectric Withstanding: AC 500V

Operating Temperature: -40°C to $+105^{\circ}\text{C}$

Max Processing Temp.: 230° for 30-60 seconds
 (260° for 10 seconds)

HOW TO ORDER:

MCT[][D][R][]S2[G][][R]
1 2 3 4 5 6 7

1- Nr. of Ways
 Double Row: 2 to 80

2- Row Version:
 (D)-Double Row

3- Pin Style
 (N)- 90°
 (R)- 180°

4- Terminal Plating:
 (E)-Sn
 (F)-FLASH Au
 (A)- $0.38\mu\text{m}$ Au
 (B)- $0.76\mu\text{m}$ Au
 (C)- $0.38\mu\text{m}$ Au/Sn
 (D)- $0.76\mu\text{m}$ Au/Sn

5- Profile:
 (G)-2,0mm

6- Options:
 (T)-Tube Packing

7- (R) RoHS Compliant



MATRIX TECNOLOGIA IND. E COM. LTDA.

UNIT	SCALE	TITLE	DATE
mm		2.0 MCT HEIGHT 2.0mm DOUBLE ROW	SEPTEMBER 2007
TOLERANCE: ± 0.25			APP. BY
		MATL	CHK. BY
		DWG. NO.	DR. BY DIEGO